

BUK9Y13-60EL

Single N-channel 60 V, 7.9 mOhm logic level MOSFET in LFPAK56 using Enhanced SOA technology 20 April 2022

Product data sheet

1. General description

Single, logic level, N-channel MOSFET in LFPAK56 using Application specific (ASFET) Enhanced SOA technology. This product has been designed and qualified to AEC-Q101 for use in linear mode in airbag applications.

2. Features and benefits

- Fully automotive qualified to AEC-Q101 at 175 °C
- Enhanced SOA technology for improved linear mode performance
- LFPAK copper clip package technology:
 - · High robustness and current handling capability
 - Gull wing leads for easy AOI inspection and exceptional board level reliability •

3. Applications

- 12 V automotive systems
- Airbag squib voltage regulator MOSFET

4. Quick reference data

Table 1 Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	-	60	V
ID	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	-	90	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	147	W
Static chara	cteristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 20 A; T _j = 25 °C; Fig. 13		4.4	6.3	7.9	mΩ
Dynamic ch	aracteristics	·	·				
Q _{GD}	gate-drain charge	$\label{eq:ID} \begin{array}{l} I_D = 20 \text{ A}; \ V_{DS} = 48 \text{ V}; \ V_{GS} = 4.5 \text{ V}; \\ T_j = 25 \ ^\circ\text{C}; \ \overline{\text{Fig. 15}}; \ \overline{\text{Fig. 16}} \end{array}$		-	11.7	23.3	nC

90 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, [1] thermal design and operating temperature.

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5. Pinning information

Table 2	. Pinning info	rmation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	mb	
2	S	source		D
3	S	source	a	
4	G	gate		G_UEA)
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT669)	mbb076 S

6. Ordering information

Table 3. Ordering information

Type number	Imber Package					
	Name	Description	Version			
BUK9Y13-60EL		plastic, single-ended surface-mounted package; 4 terminals	SOT669			

7. Marking

Table 4. Marking codes	
Type number	Marking code
BUK9Y13-60EL	91360EL

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Tj = 25 °C unless otherwise stated.

Symbol	Parameter	Conditions		Min	Мах	Unit
V _{DS}	drain-source voltage	25 °C ≤ T _j ≤ 175 °C		-	60	V
V _{GS}	gate-source voltage	DC; T _j ≤ 175 °C		-10	10	V
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 1</u>		-	147	W
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 2</u>	[1]	-	90	Α
		V _{GS} = 10 V; T _{mb} = 100 °C; <u>Fig. 2</u>		-	64	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu$ s; $T_{mb} = 25 \ ^{\circ}$ C; <u>Fig. 3;</u> Fig. 4		-	361	A
T _{stg}	storage temperature			-55	175	°C
Tj	junction temperature			-55	175	°C
Source-drai	n diode	1				
Is	source current	T _{mb} = 25 °C		-	90	А
I _{SM}	peak source current	pulsed; t _p ≤ 10 µs; T _{mb} = 25 °C		-	361	А
Avalanche r	uggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$ I_D = 49.7 \text{ A}; V_{sup} \le 60 \text{ V}; \text{ R}_{GS} = 50 \Omega; V_{GS} = 10 \text{ V}; \text{ T}_{j(init)} = 25 \text{ °C}; \text{ unclamped}; t_p = 62 \mu\text{s}; \frac{\text{Fig. 5}}{5} $	[2] [3]	-	127	mJ

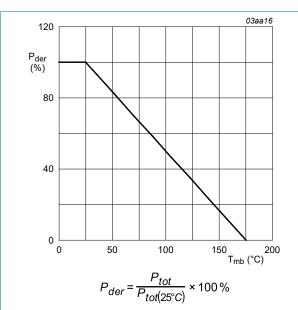
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Symbol	Parameter	Conditions		Min	Max	Unit
I _{AS}		$V_{sup} \le 60 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega; Fig. 5$	[2] [3] [4]	-	49.7	A

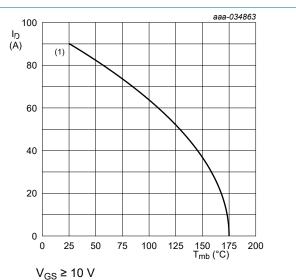
[1] 90 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

[2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

- [3] Refer to application note AN10273 for further information.
- [4] Protected by 100% test.

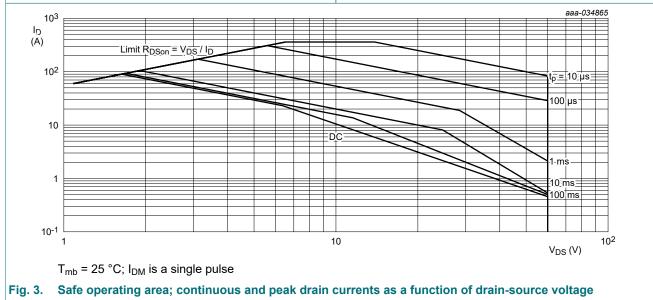


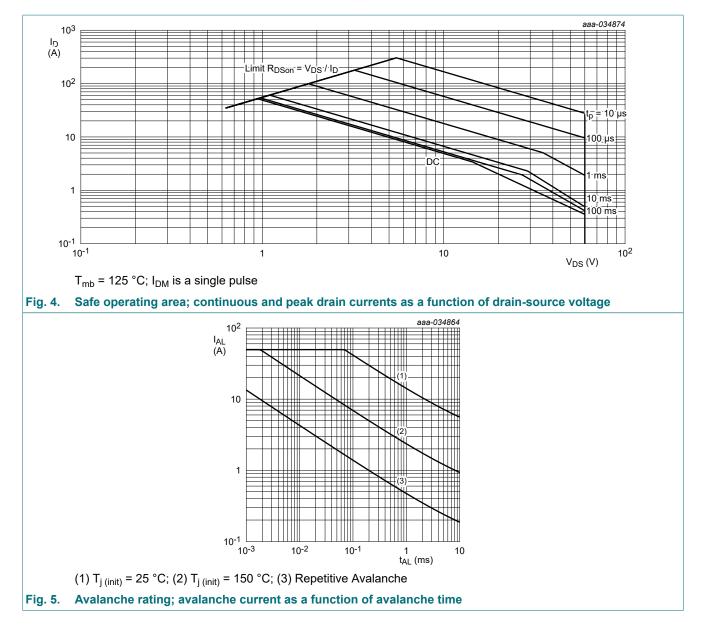




(1) 90 A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

Fig. 2. Continuous drain current as a function of mounting base temperature

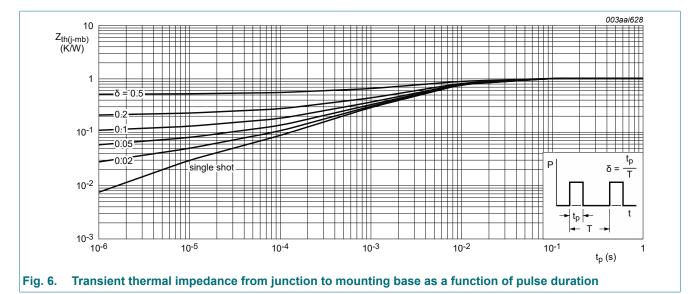




9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 6</u>	-	0.92	1.02	K/W

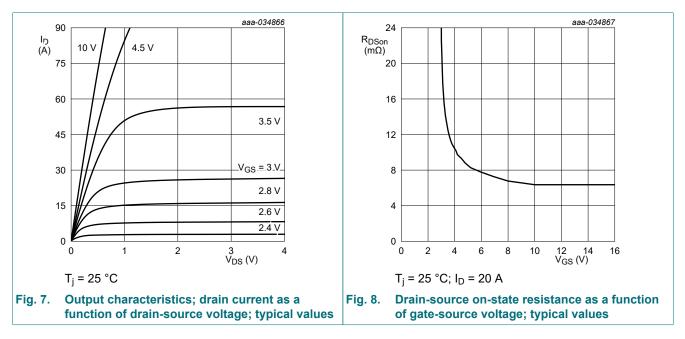


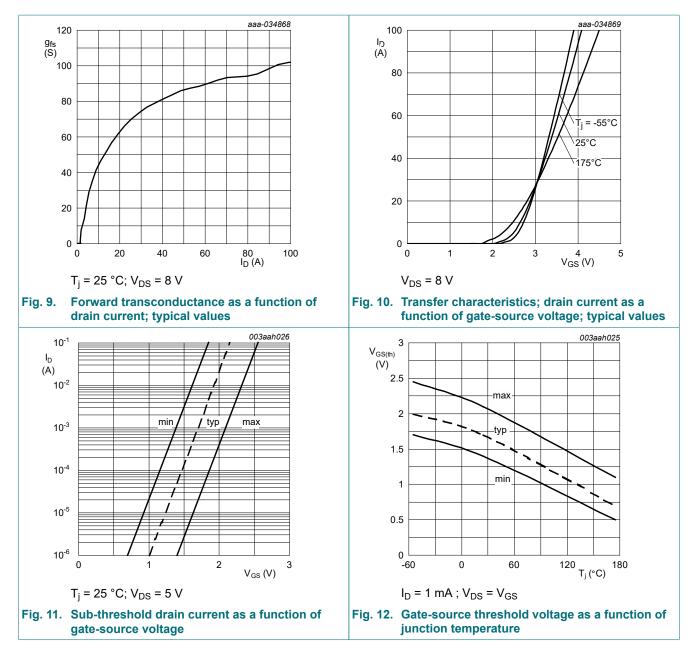
10. Characteristics

Table 7. Cha	Parameter	Conditions	Min	Turn	Max	Unit
Symbol		Conditions	MIN	Тур	Мах	Unit
Static chara	acteristics					
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^{\circ}C$	60	66	-	V
	breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C	-	61.9	-	V
		I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C	54	61	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 11;$ Fig. 12	1.4	1.78	2.1	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 12</u>	-	-	2.45	V
		I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; Fig. 12	0.5	-	-	V
I _{DSS}	drain leakage current	V _{DS} = 60 V; V _{GS} = 0 V; T _j = 25 °C	-	0.015	1	μA
		V _{DS} = 60 V; V _{GS} = 0 V; T _j = 175 °C	-	54	500	μA
I _{GSS}	gate leakage current	V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 20 A; T _j = 25 °C; Fig. 13	4.4	6.3	7.9	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 105 °C; Fig. 14	6.7	10	12.9	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 125 °C; Fig. 14	7.4	11	14.3	mΩ
		V _{GS} = 10 V; I _D = 20 A; T _j = 175 °C; Fig. 14	9.2	13.8	18.2	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 25 °C; Fig. 13	6.5	9.3	12.4	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 105 °C; Fig. 14	9.6	14.3	19.7	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 125 °C; Fig. 14	10.5	15.7	21.8	mΩ
		V _{GS} = 4.5 V; I _D = 20 A; T _j = 175 °C; Fig. 14	12.8	19.4	27.4	mΩ

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _G	gate resistance	f = 1 MHz; T _j = 25 °C		-	2.01	-	Ω
Dynamic ch	naracteristics						
Q _{G(tot)}	total gate charge	$\label{eq:ID} \begin{array}{l} I_D = 20 \text{ A}; \text{ V}_{DS} = 48 \text{ V}; \text{ V}_{GS} = 4.5 \text{ V}; \\ \text{T}_j = 25 \ ^\circ\text{C}; \ \overline{\text{Fig. 15}}; \ \overline{\text{Fig. 16}} \end{array}$		-	28	39.5	nC
		$\label{eq:ID} \begin{array}{l} I_D = 20 \text{ A}; \text{ V}_{DS} = 48 \text{ V}; \text{ V}_{GS} = 10 \text{ V}; \\ \text{T}_j = 25 \text{ °C}; \ \overline{\text{Fig. 15}}; \ \overline{\text{Fig. 16}} \end{array}$		-	58	81	nC
Q _{GS}	gate-source charge	I _D = 20 A; V _{DS} = 48 V; V _{GS} = 4.5 V;		-	8.2	12.3	nC
Q _{GD}	gate-drain charge	T _j = 25 °C; <u>Fig. 15; Fig. 16</u>		-	11.7	23.3	nC
C _{iss}	input capacitance	V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; T _j = 25 °C; <u>Fig. 17</u>		-	3229	4520	pF
C _{oss}	output capacitance			-	301	361	pF
C _{rss}	reverse transfer capacitance			-	156	213	pF
t _{d(on)}	turn-on delay time	V_{DS} = 48 V; R _L = 2.4 Ω; V _{GS} = 5 V;		-	16	-	ns
t _r	rise time	R _{G(ext)} = 5 Ω; T _j = 25 °C		-	39	-	ns
t _{d(off)}	turn-off delay time			-	34	-	ns
t _f	fall time	-		-	29	-	ns
g fs	transfer conductance	V _{DS} = 8 V; I _D = 20 A; T _j = 25 °C; <u>Fig. 9</u>		-	62.5	-	S
Source-drai	in diode						
V _{SD}	source-drain voltage	I_{S} = 20 A; V_{GS} = 0 V; T_{j} = 25 °C; <u>Fig. 18</u>		-	0.82	1	V
t _{rr}	reverse recovery time	$I_{S} = 20 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V};$		-	28	-	ns
Q _r	recovered charge	V _{DS} = 30 V; T _j = 25 °C; <u>Fig. 19</u>	[1]	-	30	-	nC

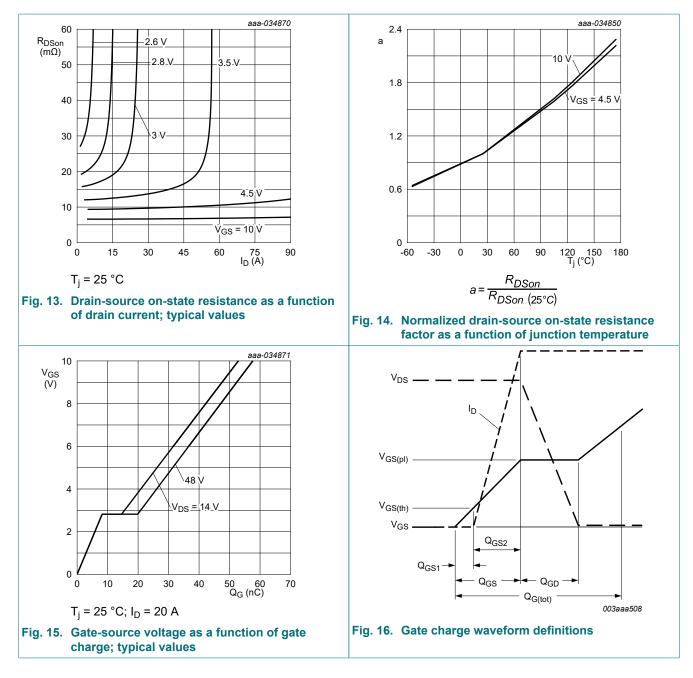
[1] includes capacitive recovery





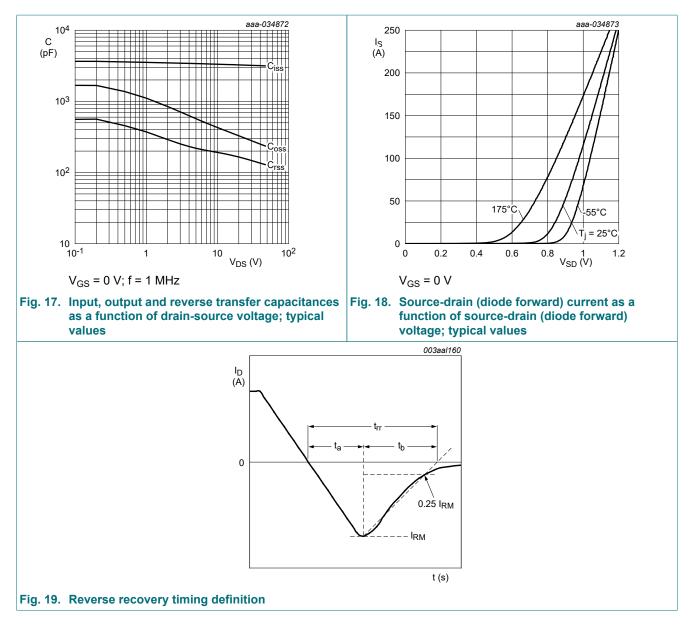
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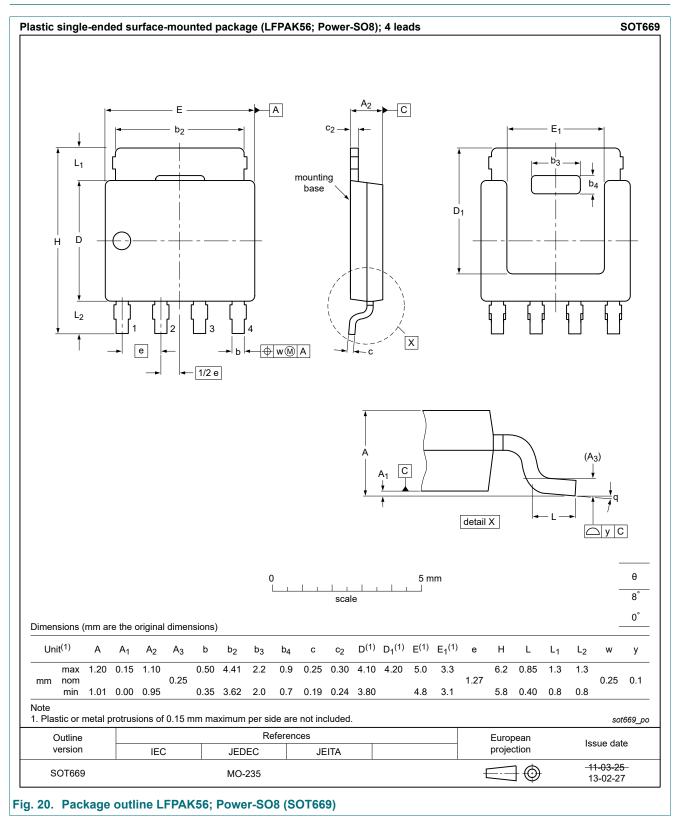
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11. Package outline



12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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